

# PROCEEDINGS OF SPIE

## ***Flexible Electronics***

**David R. Allee**  
**Eric W. Forsythe**  
*Editors*

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# Contents

v *Conference Committee*

---

## SESSION 1 FLEXIBLE ELECTRONICS I

---

- 8730 03 **High-performance logic circuits using solution-based, low-temperature semiconductors for flexible electronics** [8730-2]  
I. Mejia, A. L. Salas-Villasenor, J. W. Murphy, The Univ. of Texas at Dallas (United States); G. R. Kunnen, Arizona State Univ. (United States); K. D. Cantley, The Univ. of Texas at Dallas (United States); D. R. Allee, Arizona State Univ. (United States); B. E. Gnade, M. A. Quevedo-Lopez, The Univ. of Texas at Dallas (United States)
- 8730 04 **Flexible packaging and integration of CMOS IC with elastomeric microfluidics** [8730-3]  
B. Zhang, Q. Dong, C. E. Korman, Z. Li, M. E. Zaghoul, The George Washington Univ. (United States)

---

## SESSION 2 FLEXIBLE ELECTRONICS II

---

- 8730 09 **Flexible microstrip antennas** [8730-9]  
C. A. Cano Barrera, Univ. EAFIT (Colombia)

---

## SESSION 3 FLEXIBLE ELECTRONICS III

---

- 8730 0C **Flexible amorphous silicon PIN diode x-ray detectors** [8730-13]  
M. Marrs, E. Bawolek, J. T. Smith, G. B. Raupp, Arizona State Univ. (United States); D. Morton, U.S. Army Research Lab. (United States)

---

## SESSION 4 FLEXIBLE ELECTRONICS IV

---

- 8730 0F **Flexible digital x-ray technology for far-forward remote diagnostic and conformal x-ray imaging applications** [8730-16]  
J. Smith, M. Marrs, M. Strnad, Arizona State Univ. (United States); R. B. Apte, J. Bert, Palo Alto Research Ctr., Inc. (United States); D. Allee, N. Colaneri, Arizona State Univ. (United States); E. Forsythe, D. Morton, U.S. Army Research Lab. (United States)
- 8730 0G **Sol gel ZnO films doped with Mg and Li evaluated for charged particle detectors** [8730-17]  
J. W. Murphy, A. Eddy, The Univ. of Texas at Dallas (United States); G. R. Kunnen, Arizona State Univ. (United States); I. Mejia, K. D. Cantley, The Univ. of Texas at Dallas (United States); D. R. Allee, Arizona State Univ. (United States); M. A. Quevedo-Lopez, B. E. Gnade, The Univ. of Texas at Dallas (United States)

8730 0H **Development of a testbed for flexible a-Si:H photodiode sensing arrays** [8730-18]  
A. Dominguez, G. Kunnen, M. Vetrano, J. Smith, M. Marrs, D. R. Allee, Arizona State Univ.  
(United States)

*Author Index*

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- 4 Flexible Electronics IV  
**Kurtis Cantley**, The University of Texas at Dallas (United States)
- 5 Flexible and Wearable Electronics for Defense Applications: Joint Session with Conferences 8725 and 8730  
**Muhammad M. Hussain**, King Abdullah University of Science and Technology (Saudi Arabia)  
**Ali Javey**, University of California, Berkeley (United States)